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BIB DATA SHEET

CONFIRMATION NO. 3618

APPLICANTS Kazumi Hara, Suwa-shi, JAPAN; "CONTINUING DATA "FOREIGN APPLICATIONS "IF REQUIRED, FOREIGN FILING LICENSE GRANTED " 04/19/2004 Foreign Priority claimed	SERIAL NUM	BER	FILING or 371(c) DATE	CLASS	GROUP ART	ROUP ART UNIT		ATTORNEY DOCKET		
APPLICANTS Kazumi Hara, Suwa-shi, JAPAN; ** CONTINUING DATA ***** ** FOREIGN APPLICATIONS ***** JAPAN 2003-007281 01/15/2003 ** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 04/19/2004 Foreign Priority claimed	10/757,37	3		257	2826	2826		NO. 9319I-000647		
Kazumi Hara, Suwa-shi, JAPAN; ** CONTINUING DATA **********************************		RULE								
*** FOREIGN APPLICATIONS ************************************	Kazumi Hara, Suwa-shi, JAPAN;									
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Foreign Priority claimed										
35 USC 119(a-d) conditions met										
ACKNOWLEDGED ADDRESS HARNESS, DICKEY & PIERCE, P.L.C. P.O. BOX 828 BLOOMFIELD HILLS, MI 48303 UNITED STATES TITLE Semiconductor chip, semiconductor wafer, semiconductor device and method of manufacturing the same, circuit board, and electronic instrument FILING FEE RECEIVED 2574 PEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following: JAPAN 9 70 12 AUTHORITED 1.12 AII Fees AII Fees 1.16 Fees (Filing) 1.17 Fees (Processing Ext. of time) 1.18 Fees (Issue) Other	35 USC 119(a-d) cond					1				
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